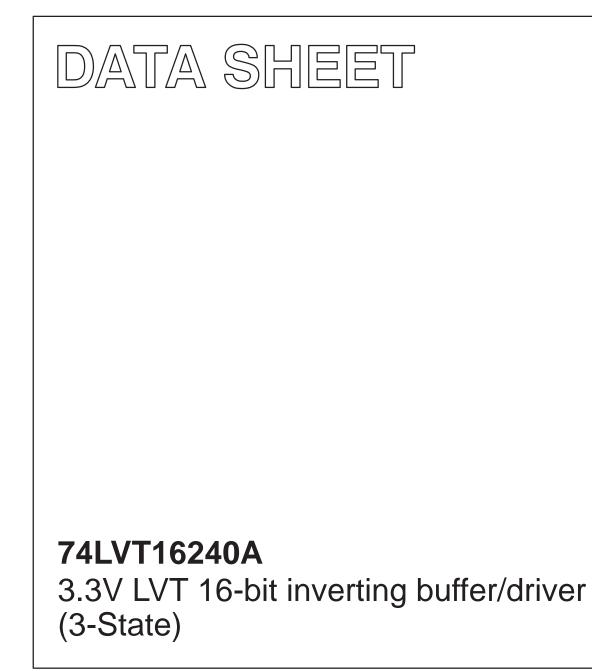
# INTEGRATED CIRCUITS



Product specification Supersedes data of 1994 Dec 15 IC23 Data Handbook

1998 Feb 19



## 74LVT16240A

#### **FEATURES**

- 16-bit bus interface
- 3-State buffers
- Output capability: +64mA/-32mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power-up 3-State
- No bus current loading when output is tied to 5V bus
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

### QUICK REFERENCE DATA

#### DESCRIPTION

The 74LVT16240A is a high-performance BiCMOS product designed for  $V_{CC}$  operation at 3.3V.

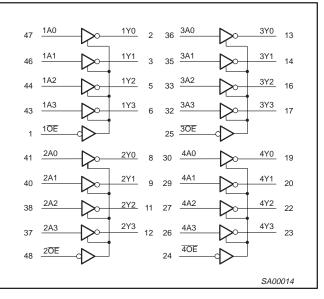
This device is an inverting 16-bit buffer that is ideal for driving bus lines. The device features four Output Enables  $(1\overline{OE}, 2\overline{OE}, 3\overline{OE}, 4\overline{OE})$ , each controlling four of the 3-State outputs.

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25°C	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay nAx to nYx	$C_L = 50 pF;$ $V_{CC} = 3.3 V$	1.9	ns
C <sub>IN</sub>	Input capacitance nOE	V <sub>1</sub> = 0V or 3.0V	3	pF
C <sub>OUT</sub>	Output capacitance	Outputs disabled; $V_0 = 0V \text{ or } 3.0V$	9	pF
I <sub>CCZ</sub>	Total supply current	Outputs disabled; $V_{CC} = 3.6V$	70	μΑ

#### **ORDERING INFORMATION**

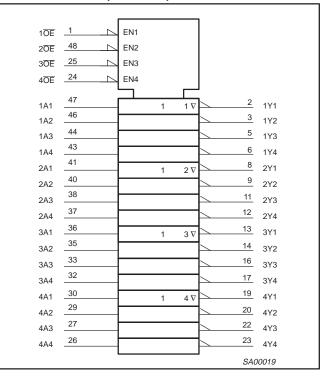
PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
48-Pin Plastic SSOP Type III	–40°C to +85°C	74LVT16240A DL	VT16240A DL	SOT370-1
48-Pin Plastic TSSOP Type II	–40°C to +85°C	74LVT16240A DGG	VT16240A DGG	SOT362-1

### LOGIC SYMBOL



## 74LVT16240A

### LOGIC SYMBOL (IEEE/IEC)



#### **PIN CONFIGURATION**

1 <del>0E</del>		48 20E
1Y0	2	47 1A0
1Y1	3	46 1A1
GND	4	45 GND
1Y2	5	44 1A2
1Y3	6	43 1A3
VCC	7	42 V <sub>CC</sub>
2Y0	8	41 2A0
2Y1	9	40 2A1
GND	10	39 GND
2Y2	11	38 2A2
2Y3	12	37 2A3
3Y0	13	36 3A0
3Y1	14	35 3A1
GND	15	34 GND
3Y2	16	33 3A2
3Y4	17	32 3A3
VCC	18	31 V <sub>CC</sub>
4Y0	19	30 4A0
4Y1	20	29 4A1
GND	21	28 GND
4Y2	22	27 4A2
4Y3	23	26 4A3
40E	24	25 3 <del>0</del> E
	L	
		SA00013

### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
47, 46, 44, 43, 41, 40, 38, 37, 36, 35, 33, 32, 30, 29, 27, 26	1A0-1A3 2A0-2A3 3A0-3A3 4A0-4A3	Data inputs
2, 3, 5, 6, 8, 9, 11, 12, 13, 14, 16, 17, 19, 20, 22, 23	1 <u>7</u> 0-1 <u>7</u> 3 2 <u>7</u> 0-2 <u>7</u> 3 3 <u>7</u> 0-3 <u>7</u> 3 4 <u>7</u> 0-4 <u>7</u> 3	Data outputs
1, 48, 25, 24	1 <u>0E,</u> 2 <u>0E,</u> 3 <u>0E,</u> 4 <u>0E</u>	Output enables
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V <sub>CC</sub>	Positive supply voltage

### **FUNCTION TABLE**

Inp	uts	Outputs
nOE	nAx	nYx
L	L	Н
L	Н	L
Н	Х	Z

H = High voltage level

L = Low voltage level

X = Don't care

Z = High Impedance "off" state

1998 Feb 19

## 74LVT16240A

## ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

SYMBOL	PARAMETER CONDITIONS		RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	-50	mA
VI	DC input voltage <sup>3</sup>		-0.5 to +7.0	V
I <sub>OK</sub>	DC output diode current	V <sub>O</sub> < 0	-50	mA
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	Output in Off or High state	-0.5 to +7.0	V
I <sub>OUT</sub>	DC output current	Output in Low state	128	
		Output in High state	-64	- mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction

temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIM	UNIT	
STMBOL	PARAMETER	MIN	MAX	
V <sub>CC</sub>	DC supply voltage	2.7	3.6	V
VI	Input voltage	0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0		V
V <sub>IL</sub>	Input voltage		0.8	V
I <sub>OH</sub>	High-level output current		-32	mA
I <sub>OL</sub>	Low-level output current		32	mA
	Low-level output current; current duty cycle $\leq$ 50%; f $\geq$ 1kHz		64	
Δt/Δv	Input transition rise or fall rate; Outputs enabled		10	ns/V
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C

## DC ELECTRICAL CHARACTERISTICS

				I	IMITS		
SYMBOL PARAMETER		TEST CONDITIONS		Temp = -40°C to +85°C			UNIT
						MAX	1
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = 2.7V; I <sub>IK</sub> = -18mA			-0.85	1.2	V
	$V_{CC} = 2.7$ to 3.6V; $I_{OH} = -100\mu A$		V <sub>CC</sub> -0.2	V <sub>CC</sub>			
V <sub>OH</sub>	V <sub>OH</sub> High-level output voltage	V <sub>CC</sub> = 2.7V; I <sub>OH</sub> = -8mA		2.4	2.5		V
		V <sub>CC</sub> = 3.0V; I <sub>OH</sub> = -32mA		2.0	2.3		1
		V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 100µA			0.07	0.2	
		V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 24mA			0.03	0.5	1
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 16mA			0.25	0.4	V
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 32mA			0.30	0.5	1
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 64mA			0.40	0.55	
		$V_{CC} = 3.6V; V_I = V_{CC} \text{ or } GND$	Control pins		0.1	±1.0	
		$V_{CC} = 0 \text{ or } 3.6 \text{V}; \text{ V}_{\text{I}} = 5.5 \text{V}$		0.4	10	μA	
II Input leakage current	$V_{CC} = 3.6V; V_{I} = V_{CC}$	Data nine4		0.1	1		
	$V_{CC} = 3.6V; V_{I} = 0$	Data pins <sup>4</sup>		-0.4	-5		
I <sub>OFF</sub>	Output off current	$V_{CC} = 0V$ ; $V_{I}$ or $V_{O} = 0$ to 4.5V	-		0.1	±100	μA
		$V_{CC} = 3V; V_{I} = 0.8V$		75	135		
I <sub>HOLD</sub>	Bus Hold current A inputs <sup>6</sup>	$V_{CC} = 3V; V_{I} = 2.0V$	-75	-135		μΑ	
		$V_{CC} = 0V$ to 3.6V; $V_{CC} = 3.6V$		±500			1
$I_{\text{EX}}$	Current into an output in the High state when $V_O > V_{CC}$	$V_{O} = 5.5V; V_{CC} = 3.0V$			50	125	μΑ
I <sub>PU/PD</sub>	Power up/down 3-State output current <sup>3</sup>	$V_{CC} \le 1.2$ V; $V_O = 0.5$ V to $V_{CC}$ ; $V_I = GNE OE/OE = Don't care$	D or V <sub>CC</sub>		1	±100	μΑ
I <sub>OZH</sub>	3-State output High current	$V_{CC} = 3.6V; V_{O} = 3.0V; V_{I} = V_{IL} \text{ or } V_{IH}$			0.5	5	
I <sub>OZL</sub>	3-State output Low current	$V_{CC} = 3.6V; V_O = 0.5V; V_I = V_{IL} \text{ or } V_{IH}$		0.5	-5	μA	
ICCH		$V_{CC} = 3.6V$ ; Outputs High, $V_I = GND$ or $V_{CC}$ , $I_O = 0$			0.07	0.12	
I <sub>CCL</sub>	Quiescent supply current	$V_{CC}$ = 3.6V; Outputs Low, $V_{I}$ = GND or V		4.0	6.0	mA	
I <sub>CCZ</sub>	]	$V_{CC}$ = 3.6V; Outputs Disabled; $V_{I}$ = GND		0.07	0.12		
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	$V_{CC}$ = 3V to 3.6V; One input at $V_{CC}$ -0.6V Other inputs at $V_{CC}$ or GND	V,		0.1	0.20	mA

#### NOTES:

1. All typical values are at  $V_{CC} = 3.3V$  and  $T_{amb} = 25^{\circ}C$ . 2. This is the increase in supply current for each input at the specified voltage level other than  $V_{CC}$  or GND 3. This parameter is valid for any  $V_{CC}$  between 0V and 1.2V with a transition time of up to 10msec. From  $V_{CC} = 1.2V$  to  $V_{CC} = 3.3V \pm 0.3V$  a transition time of 100 $\mu$ sec is permitted. This parameter is valid for T<sub>amb</sub> = 25°C only.

4. Unused pins at V<sub>CC</sub> or GND.

I<sub>CCZ</sub> is measured with outputs pulled to V<sub>CC</sub> or GND.
This is the bus hold overdrive current required to force the input to the opposite logic state.

### **AC CHARACTERISTICS**

GND = 0V;  $t_R = t_F = 2.5ns$ ;  $C_L = 50pF$ ;  $R_L = 500\Omega$ ;  $T_{amb} = -40^{\circ}C$  to +85°C.

		LIMITS					
SYMBOL	PARAMETER	WAVEFORM	V <sub>C</sub>	c = 3.3V ±0.	.3V	$V_{CC} = 2.7V$	UNIT
			MIN	TYP <sup>1</sup>	MAX	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay nAx to nYx	1	0.5 0.5	1.8 2.0	3.2 3.2	4.0 4.0	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output enable time to High and Low level	2	1.0 1.0	2.3 2.1	4.0 4.4	5.0 4.8	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output disable time from High and Low Level	2	1.0 1.0	3.2 3.0	4.5 4.4	5.0 4.8	ns

#### NOTE:

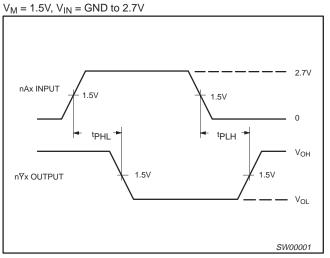
1. All typical values are at  $V_{CC} = 3.3V$  and  $T_{amb} = 25^{\circ}C$ .

## 74LVT16240A

74LVT16240A

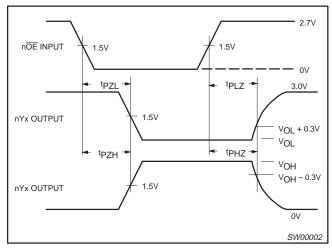
# 3.3V 16-bit inverting buffer/driver (3-State)

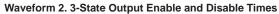
## AC WAVEFORMS

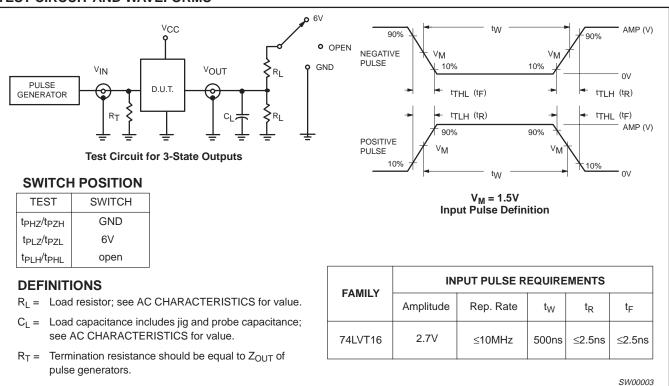


Waveform 1. Input (nAx) to Output (nYx) Propagation Delays



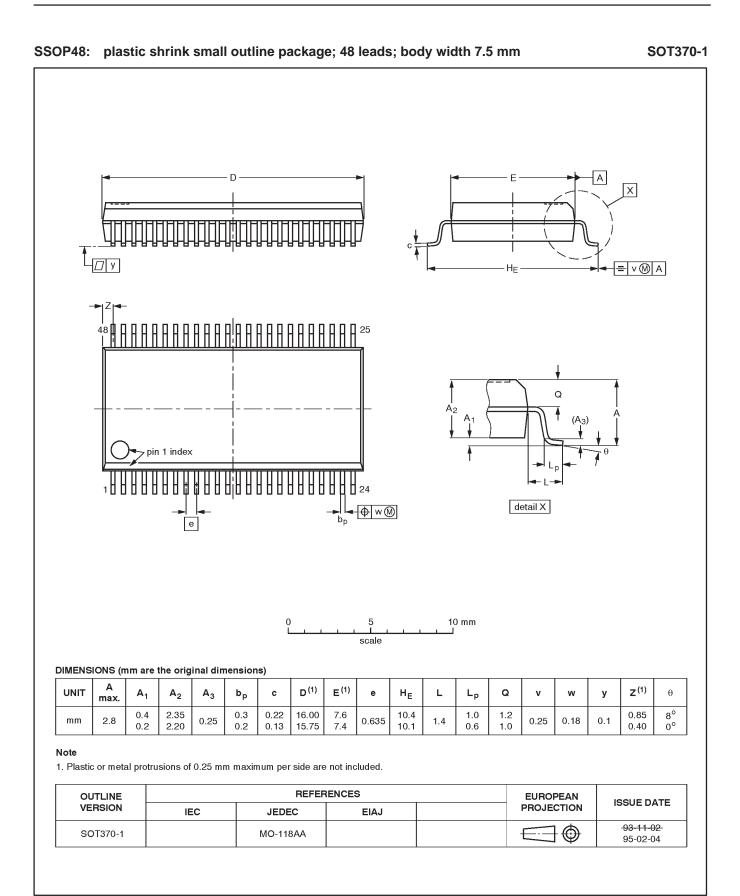




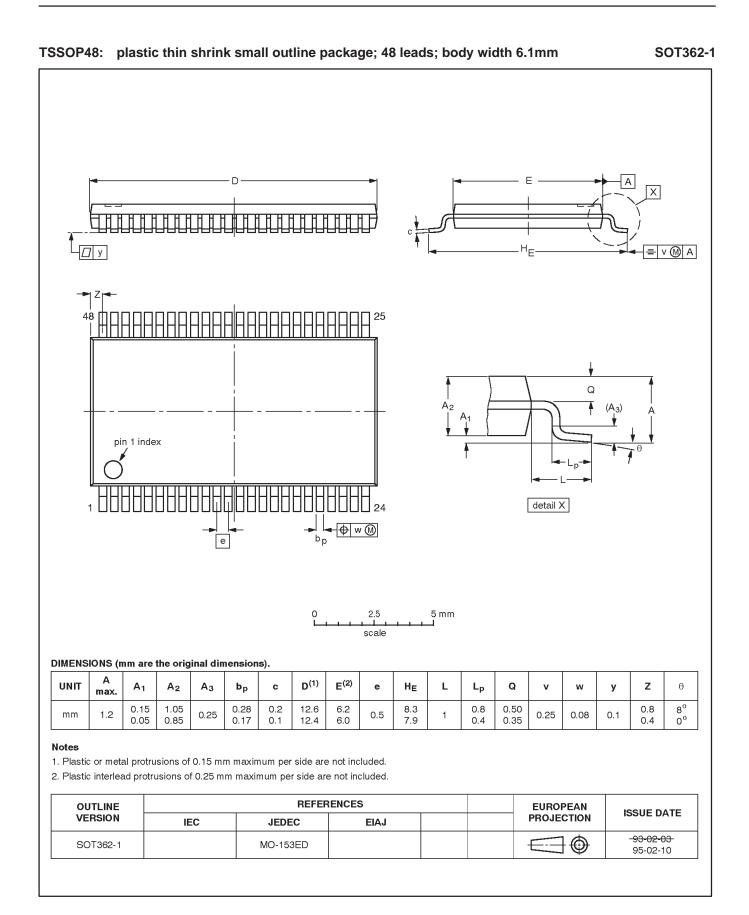


#### 1998 Feb 19

## 74LVT16240A



## 74LVT16240A



### Product specification

# 3.3V LVT 16-bit inverting buffer/driver (3-State)

# 74LVT16240A

NOTES

## 74LVT16240A

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

### Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

**Right to make changes** — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1998 All rights reserved. Printed in U.S.A.

print code

Document order number:

Date of release: 05-96 9397-750-03547

Let's make things better.



PHILIPS